



ZPMV2.E488074 - Wiring, Printed - Component

Wiring, Printed - Component

ShenZhen JDB Technology Co LTD
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 Shenzhen, Guangdong 518103 China

E488074

Type	Cond Width		Min Cond Thk	SS/ DS/ DSO	Area Diam	Date After	Max Report Surface Mount	Assembly Solder Process	Temp °C	Solder Limits °C	Oper Temp °C	Max Flame Class	Meets UL796	C T	DSR	I
	mm	mm														
Multilayer printed wiring boards																
JDB-M	0.1	0.1	17 Int:34	DS	25.4	No	-	-	-	288	20	130	V-0	All	*	
Single layer printed wiring boards																
JDB-D	0.1	0.1	17	DS	25.4	No	-	-	-	288	20	130	V-0	All	*	

* - CTI marking is optional and may be marked on the printed wiring board.

Marking: Company name or file number and type designation. May be followed by a suffix to denote factory identification or flammability classification..

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